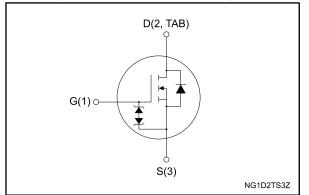


# N-channel 800 V, 0.55 Ω typ., 8 A MDmesh<sup>™</sup> K5 Power MOSFET in a DPAK package

Datasheet - production data

# TAB 2 3 1 DPAK

Figure 1: Internal schematic diagram



## Features

Order code	V <sub>DS</sub>	V <sub>DS</sub> R <sub>DS(on)</sub> max.	
STD10LN80K5	800 V	0.63 Ω	8 A

- Industry's lowest R<sub>DS(on)</sub> x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

## **Applications**

• Switching applications

# Description

This very high voltage N-channel Power MOSFET is designed using MDmesh<sup>™</sup> K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

### Table 1: Device summary

Order code	Marking	Package	Packing
STD10LN80K5	10LN80K5	DPAK	Tape and reel

This is information on a product in full production.

### Contents

# Contents

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# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate-source voltage	± 30	V
Ι <sub>D</sub>	Drain current (continuous) at $T_c = 25 \ ^{\circ}C$	8	А
ID	Drain current (continuous) at $T_c = 100 \ ^\circ C$	5	А
I <sub>D</sub> <sup>(1)</sup>	Drain current (pulsed)	32	А
P <sub>TOT</sub>	Total dissipation at $T_C = 25 \text{ °C}$	110	W
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	4.5	
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	50	V/ns
Tj	Operating junction temperature range	55 to 150	°C
T <sub>stg</sub>	Storage temperature range	- 55 to 150	

### Notes:

 $\ensuremath{^{(1)}}\ensuremath{\mathsf{Pulse}}$  width limited by safe operating area.

 $^{(2)}I_{SD}$   $\leq$  8 A, di/dt  $\leq$  100 A/µs; V\_{DS} peak < V\_(BR)DSS, V\_{DD}=640 V  $^{(3)}V_{DS}$   $\leq$  640 V

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	1.14	°C/W
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	50	°C/W

### Notes:

 $^{(1)}\!When$  mounted on FR-4 board of 1 inch² , 2 oz Cu

### Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )	2.7	А
E <sub>AS</sub>	Single pulse avalanche energy (starting $T_j$ = 25 ° C, $I_D$ = $I_{AR},V_{DD}$ = 50 V)	240	mJ



# 2 Electrical characteristics

 $T_C = 25$  ° C unless otherwise specified

Table 5: On/off-state							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA	800			V	
I <sub>DSS</sub> Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 800 V$			1	μA		
	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 800 V$ $T_{C} = 125 \ ^{\circ}C^{(1)}$			50	μA	
I <sub>GSS</sub>	Gate body leakage current	$V_{\text{DS}} = 0 \text{ V},  V_{\text{GS}} = \pm 20 \text{ V}$			± 10	μA	
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 100 \ \mu A$	3	4	5	V	
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS}$ = 10 V, $I_D$ = 4 A		0.55	0.63	Ω	

### Table 5: On/off-state

#### Notes:

<sup>(1)</sup>Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	427	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 100 V, f = 1 MHz, V <sub>GS</sub> = 0 V	-	43	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	VGS - 0 V	-	0.25	-	pF
C <sub>o(tr)</sub> <sup>(1)</sup>	Equivalent capacitance time related	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$ V	-	72	-	pF
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related			27	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz , I <sub>D</sub> = 0 A	-	7	-	Ω
Qg	Total gate charge	$V_{DD} = 640 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	-	15	-	nC
$Q_gs$	Gate-source charge	V <sub>GS</sub> = 10 V	-	4.2	-	nC
$Q_gd$	Gate-drain charge	See Figure 16: "Test circuit for gate charge behavior"	-	9	-	nC

Table	6٠	Dvna	mic
Iable	υ.	Dyna	mc

#### Notes:

 $^{(1)}$  Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

 $^{(2)}\mathsf{E}\mathsf{nergy}$  related is defined as a constant equivalent capacitance giving the same stored energy as Coss when  $\mathsf{V}_{\mathsf{DS}}$  increases from 0 to 80%  $\mathsf{V}_{\mathsf{DSS}}$ 



### Electrical characteristics

Table 7: Switching times								
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD}\text{=}$ 400 V, $I_{D}$ = 4 A, $R_{G}$ = 4.7 $\Omega$	-	11.8	-	ns		
tr	Rise time	V <sub>GS</sub> = 10 V	-	10	-	ns		
t <sub>d(off)</sub>	Turn-off delay time	See Figure 15: "Test circuit for resistive load switching times" and	-	28	-	ns		
t <sub>f</sub>	Fall time	Figure 20: "Switching time waveform"	-	13	-	ns		

#### Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		8	А
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		32	А
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 8 A, V <sub>GS</sub> = 0 V	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 8 A, di/dt = 100 A/µs,	-	350		ns
Q <sub>rr</sub>	Reverse recovery charge	V <sub>DD</sub> = 60 V See Figure 17: "Test circuit for	-	3.9		μC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times"	-	22.5		А
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 8 A, di/dt = 100 A/µs,	-	505		ns
Q <sub>rr</sub>	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{\text{j}} = 150 \text{ °C}$ See Figure 17: "Test circuit for	-	5		μC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times"	-	20		А

### Notes:

 $^{(1)}\mbox{Pulse}$  width limited by safe operating area

 $^{(2)}$ Pulsed: pulse duration = 300  $\mu$  s, duty cycle 1.5%

#### Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)GSO</sub>	Gate-source breakdown voltage	$I_{GS}$ = ± 1mA, $I_{D}$ = 0 A	30	-	-	V

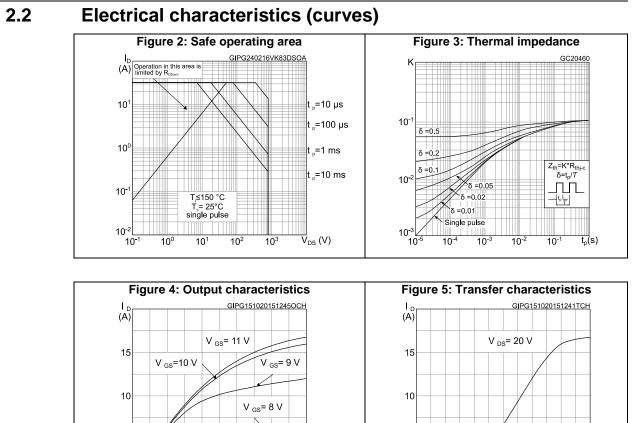
The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.



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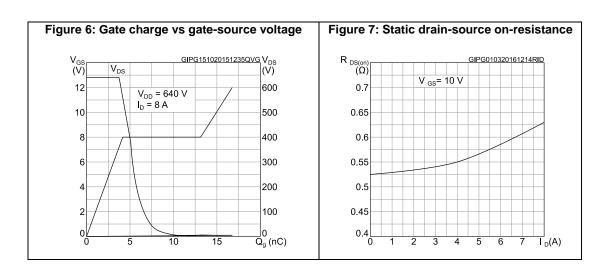
V  $_{GS}$ = 7 V

12

V <sub>GS</sub>= 6 V

V<sub>DS</sub>(V)

16



5

0L

6

8

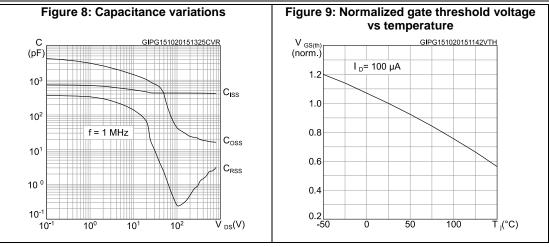
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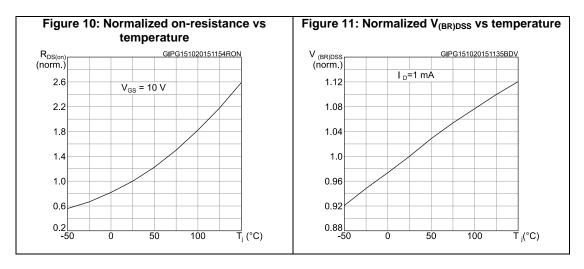
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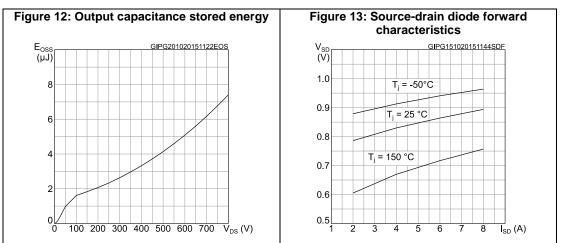
V<sub>GS</sub>(V)



#### **Electrical characteristics**



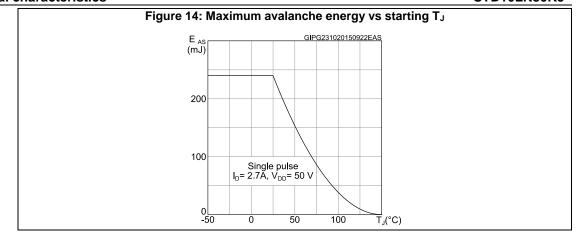






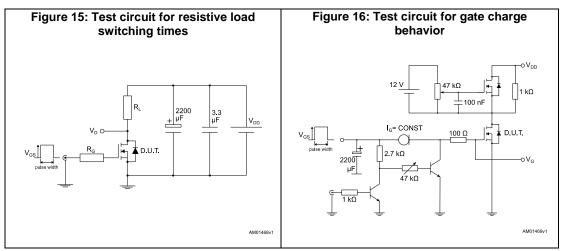
### **Electrical characteristics**

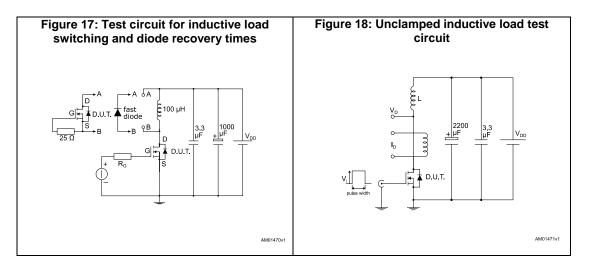
### STD10LN80K5

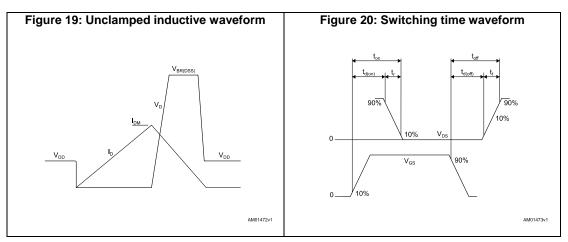




# 3 Test circuits









# 4 Package information

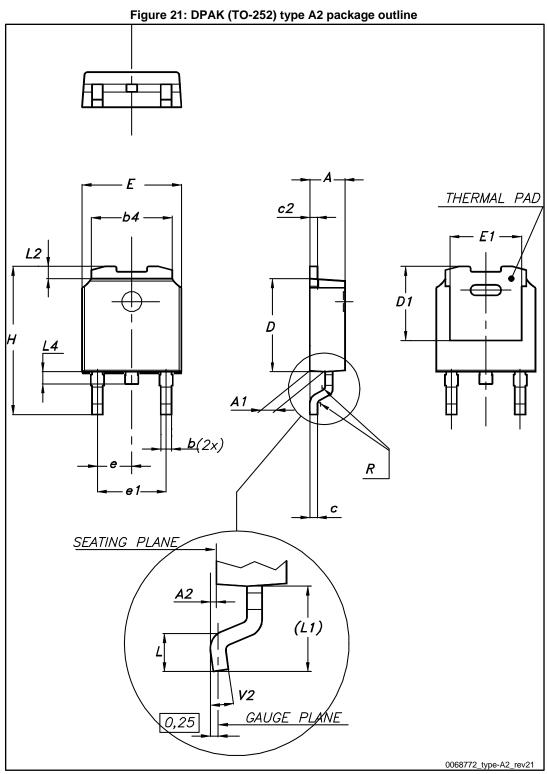
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.





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# DPAK (TO-252) type A2 package information



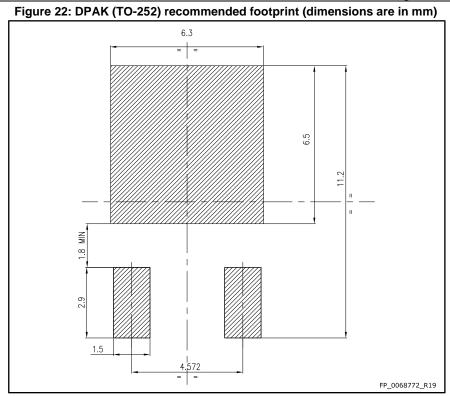
### Package information

### STD10LN80K5

nformation			STD10LN80K5			
Table 10: DPAK (TO-252) type A2 mechanical data						
Dim.	mm					
Dini.	Min.	Тур.	Max.			
A	2.20		2.40			
A1	0.90		1.10			
A2	0.03		0.23			
b	0.64		0.90			
b4	5.20		5.40			
с	0.45		0.60			
c2	0.48		0.60			
D	6.00		6.20			
D1	4.95	5.10	5.25			
E	6.40		6.60			
E1	5.10	5.20	5.30			
е	2.16	2.28	2.40			
e1	4.40		4.60			
н	9.35		10.10			
L	1.00		1.50			
L1	2.60	2.80	3.00			
L2	0.65	0.80	0.95			
L4	0.60		1.00			
R		0.20				
V2	0°		8°			

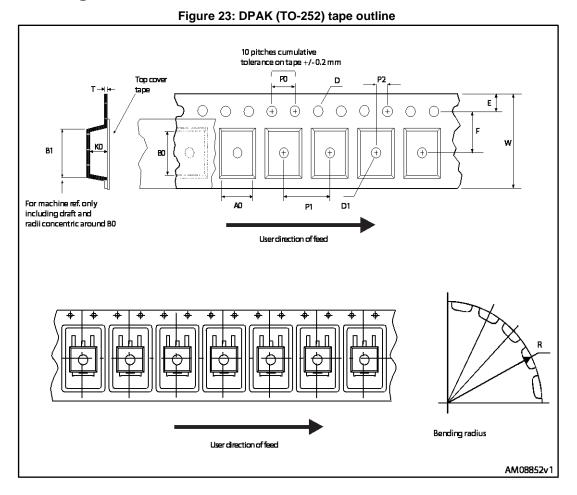


Package information





# 4.2 Packing information





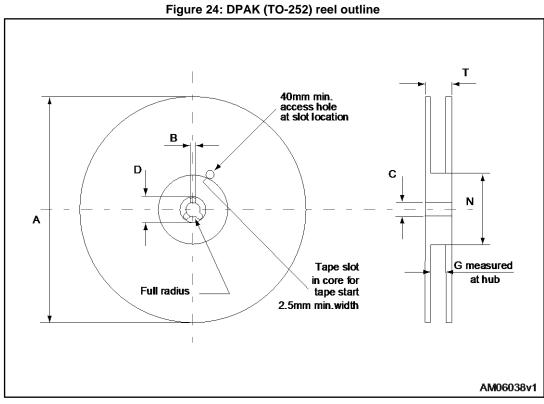


Table 11: DPAK (TO-252) tape and reel mechanical data							
Таре			Reel				
Dim.	mm		Dim	mm			
	Min.	Max.	Dim.	Min.	Max.		
A0	6.8	7	А		330		
B0	10.4	10.6	В	1.5			
B1		12.1	С	12.8	13.2		
D	1.5	1.6	D	20.2			
D1	1.5		G	16.4	18.4		
E	1.65	1.85	N	50			
F	7.4	7.6	Т		22.4		
K0	2.55	2.75					
P0	3.9	4.1	Base	e qty.	2500		
P1	7.9	8.1	Bulk qty. 25		2500		
P2	1.9	2.1					
R	40						
Т	0.25	0.35					
W	15.7	16.3					

Table 11: DPAK (TO-252) tape and reel mechanical data



# 5 Revision history

Table 12: Document revision history

Date	Revision	Changes
09-Mar-2016	1	First release.



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